



ZVP3310F

#### SOT23 P-CHANNEL ENHANCEMENT MODE VERTICAL DMOS FET

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max
-100V	20Ω @ V <sub>GS</sub> = -10V	-75mA

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Load Switching

### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>ZVP3310FQ</u>)

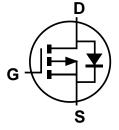
#### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
  UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
  Solderable per MIL-STD-202, Method 208 (63)
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)

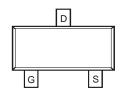
SOT23



Top View



Internal Schematic



Top View

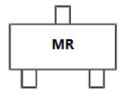
#### Ordering Information (Note 4)

Part Number	Case	Packaging
ZVP3310FTA	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**



MR = Product Type Marking Code



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		$V_{DSS}$	-100	V
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Continuous Drain Current	Steady State	I <sub>D</sub>	-75	mA
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	-1.2	Α
Pulsed Source Current (10µs Pulse, Duty Cycle = 1%)		I <sub>SM</sub>	-1.2	Α

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (@T <sub>A</sub> = +25°C)	P <sub>D</sub>	330	mW
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

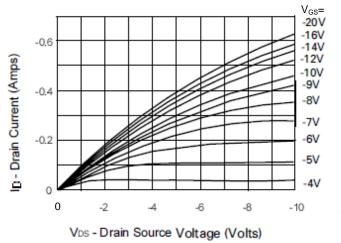
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

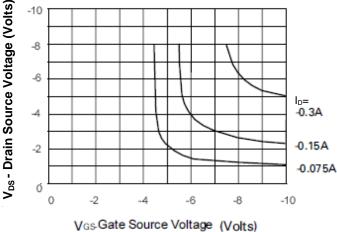
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)	<u> </u>		-				
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-100	_	_	V	$V_{GS} = 0V$ , $I_D = -1mA$	
	I <sub>DSS</sub>	_	_	-1	μA	V <sub>DS</sub> = -100V, V <sub>GS</sub> = 0V	
Zero Gate Voltage Drain Current		_	_	-50	μA	V <sub>DS</sub> = -80V, V <sub>GS</sub> = 0V, T = +125°C	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±20	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)						•	
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-1.5	_	-3.5	V	$V_{DS} = V_{GS}$ , $I_D = -1mA$	
Static Drain-Source On-Resistance (Note 5)	R <sub>DS(ON)</sub>	_	_	20	Ω	$V_{GS} = -10V, I_D = -150mA$	
On-State Drain Current (Note 5)	I <sub>D(ON)</sub>	-300	_	_	mA	$V_{DS} = -25V, V_{GS} = -10V$	
Forward Transconductance (Note 5)	gfs	50	_	_	mS	$V_{DS} = -25V, I_{D} = -150mA$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	C <sub>iss</sub>	_	_	50			
Output Capacitance	Coss	_	_	15	pF	$V_{DS} = -25V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	_	5			
Turn-On Delay Time	t <sub>D(ON)</sub>	_	_	8			
Turn-On Rise Time	t <sub>R</sub>	_	_	8	ns	V 25V L 150m A	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	_	8	1115	$V_{DD} = -25V, I_D = -150mA$	
Turn-Off Fall Time	t <sub>F</sub>	_		8			

Notes:

- 5. Measured under pulsed conditions. Width = 300ms. Duty cycle <=2%.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Guaranteed by design. Not subject to product testing.



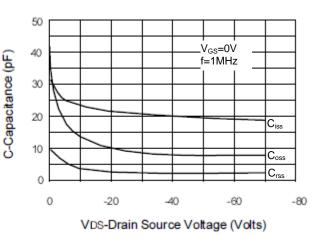




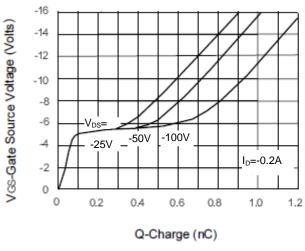
#### Saturation Characteristics

100 90 gfs-Transconductance (mS) V<sub>DS</sub>=-10V 80 70 60 50 40 30 20 10 0 -0.1 -0.2 -0.3 -0.4 -0.5 -0.6 -0.7 -0.8 ID- Drain Current (Amps)

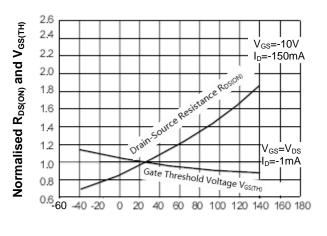
Voltage Saturation Characteristics



**Transconductance v Drain Current** 



Capacitance v Drain-Source Voltage



Gate Charge v Gate-Source Voltage

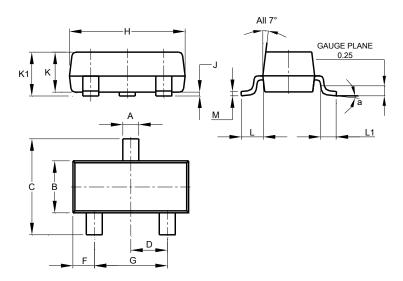
 $\label{eq:TJ-Junction Temperature (°C)} T_{J} \text{- Junction Temperature (°C)}$  Normalised  $R_{DS(ON)}$  and  $V_{GS(TH)}$  v Temperature



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23

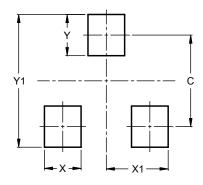


SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
M	0.085	0.150	0.110		
а	0°	8°			
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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